Film Capacitors

Metallized Polypropylene Film Capacitors (MKP)

Series/Type: **B32774 ... B32778**

Date: October 2014

Recommended applications

- Frequency converters
- Industrial and high-end power supplies
- Solar inverters

Climatic

- Max. operating temperature: 105 °C (case)
- Climatic category (IEC 60068-1): 40/105/56

Construction

- Dielectric: Polypropylene (MKP)
- Plastic case (UL 94 V-0)
- Epoxy resin sealing (UL 94 V-0)

Features

- Capacitance values up to 480 µF
- High CV product, compact
- Good self-healing properties
- Over-voltage capability
- Low losses with high current capability
- High reliability
- Long useful life
- RoHS-compatible

Terminals

- Parallel wire leads, lead-free tinned
- 2-pin, 4-pin and 12-pin versions
- Standard lead lengths: 6 –1 mm

Marking

Manufacturer's logo and lot number, date code, rated capacitance (coded), capacitance tolerance (code letter) and rated DC voltage

Delivery mode

Bulk (untaped)

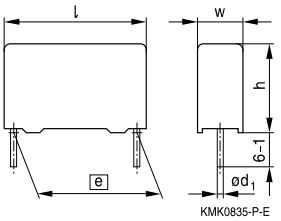
Dimensional drawings

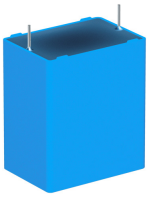
Dimensions in mm

Number of wires	Lead spacing e ±0.4	Lead diameter d_1 ±0.05	Type
2-pin	27.5	0.8	B32774D
2-pin	37.5	1.0	B32776E
2-pin	37.5	1.0	B32776T
4-pin	37.5	1.2	B32776G
4-pin	37.5	1.2	B32776T
4-pin	52.5	1.2	B32778T
4-pin	52.5	1.2	B32778G
12-pin	52.5	1.2	B32778J

Dimensional drawings 2-pin versions

B32774D, B32776E

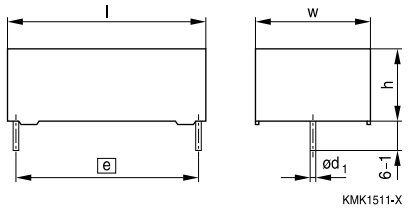


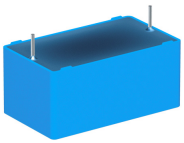


	B32774D	B32776E
Lead spacing e ±0.4:	27.5	37.5
Lead diameter d_1:	0.8	1.0

(Dimensions in mm)

B32776T (low profile)



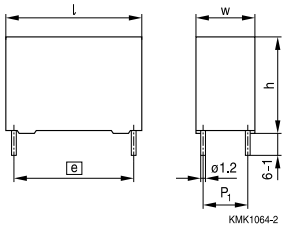


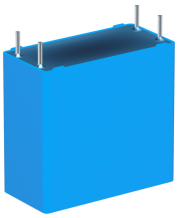
Lead spacing e ±0.4:	37.5
Lead diameter d_1:	1.0

(Dimensions in mm)

Dimensional drawings 4-pin versions

B32776G, B32778G

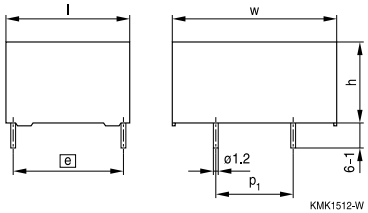


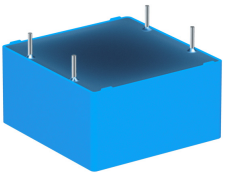


	B32776G	B32778G
Lead spacing e ±0.4:	37.5	52.5
Lead diameter d_1:	1.2	1.2

(Dimensions in mm)

B32776T, B32778T (low profile)



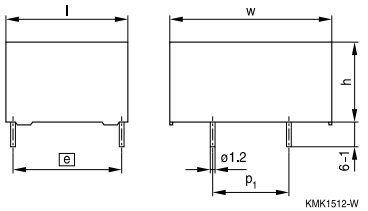


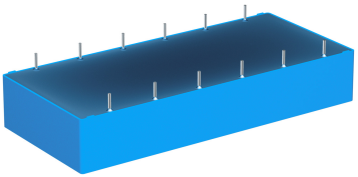
	B32776T	B32778T
Lead spacing e ±0.4:	37.5	52.5
Lead diameter d_1:	1.2	1.2

(Dimensions in mm)

Dimensional drawing 12-pin version

B32778J



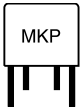


Lead spacing e ±0.4:	52.5
Lead diameter d_1:	1.2

(Dimensions in mm)

Overview of available types

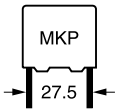
Lead spacing	27.5 mm				37.5 mm					
Type	B32774				B32776					
Page	7				8					
V_R (V DC)	450	800	1100	1300	450	575	800	900	1100	1300
C_R (µF)										
1.5				■						
2.0			■							
2.7										■
3.0		■		■						
3.3			■							
3.5										■
3.9									■	
5.0	■	■	■	■				■	■	
6.8							■			
7.0			■							
7.5								■		
8.0										■
8.5						■	■			
9.0										■
10	■									■
12		■			■	■			■	■
13									■	
14							■		■	■
15							■	■		
16					■			■	■	■
20							■	■	■	
22	■						■	■	■	
25						■	■	■		
30					■	■	■	■		
35					■	■	■			
40					■					
45						■				
50					■	■				
60					■					
65					■					



B32774 ... B32778

MKP DC link – high density series up to 480 µF

Lead spacing	52.5 mm					
Type	B32778					
Page	11					
V_R (V DC)	450	575	800	900	1100	1300
C_R (µF)						
14						
20						
25						
27						
30						
35						
38						
40						
42						
45						
50						
55						
58						
60						
70						
75						
80						
90						
100						
110						
120						
130						
150						
170						
180						
200						
210						
270						
360						
480						



Ordering codes and packing units (lead spacing 27.5 mm)

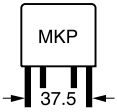
C_R[1] µF	Max. dimensions w × h × l mm	P_1 mm	Ordering code (composition see below)	$I_{RMS,max}$[2] 70 °C 10 kHz A	ESR_{typ} 70 °C 10 kHz mΩ	ESL_{typ}[3] 70 °C 10 kHz nH	tan δ 1 kHz 10^{-3}	tan δ 10 kHz 10^{-3}	pcs. MOQ
$V_{R,70\,°C}$ = 450 V DC, $V_{op,85\,°C}$ = 450 V DC									
5.0	11.0 × 21.0 × 31.5	–	B32774D4505+000	5.0	21.1	19.0	1.2	10.7	2352
10.0	15.0 × 24.5 × 31.5	–	B32774D4106+000	8.0	10.9	24.0	1.2	11.0	1680
22.0	22.0 × 36.5 × 31.5	–	B32774D4226+000	14.5	5.4	30.0	1.3	12.1	784
$V_{R,70\,°C}$ = 800 V DC, $V_{op,85\,°C}$ = 700 V DC									
3.0	11.0 × 21.0 × 31.5	–	B32774D8305+000	4.5	24.8	19.0	0.9	7.6	2352
5.0	14.0 × 24.5 × 31.5	–	B32774D8505+000	6.5	15.3	23.0	0.9	7.7	1848
12.0	22.0 × 36.5 × 31.5	–	B32774D8126+000	13.0	6.8	34.0	1.0	8.3	784
$V_{R,70\,°C}$ = 1100 V DC, $V_{op,85\,°C}$ = 920 V DC									
2.0	12.5 × 21.5 × 31.5	–	B32774D0205+000	4.5	26.3	19.0	0.7	5.3	2100
3.3	18.0 × 27.5 × 31.5	–	B32774D0335+000	7.0	16.2	22.0	0.7	5.4	1428
5.0	19.0 × 30.0 × 31.5	–	B32774D0505+000	9.0	10.9	27.0	0.7	5.5	896
7.0	22.0 × 36.5 × 31.5	–	B32774D0705+000	12.0	8.1	30.0	0.7	5.8	784
$V_{R,70\,°C}$ = 1300 V DC, $V_{op,85\,°C}$ = 1100 V DC									
1.5	12.5 × 21.5 × 31.5	–	B32774D1155K000	4.4	31.3	20.0	0.6	4.8	2100
3.0	18.0 × 27.5 × 31.5	–	B32774D1305K000	7.0	16.0	24.0	0.6	4.9	1428
5.0	22.0 × 36.5 × 31.5	–	B32774D1505K000	10.5	9.8	33.0	0.7	5.1	784

MOQ = Minimum Order Quantity, consisting of 4 packing units.
Intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:
J = ±5%
K = ±10%

1) Capacitance value measured at 1 kHz
2) Max ripple current I_{RMS} at 70 °C, 10 kHz for $\Delta T \leq 20$ °C at $\Delta ESR_{typ} \leq \pm 5\%$
3) Typical ESL value measured at resonance frequency (see specific graphs of Z vs freq)



B32776

MKP DC link – high density series – up to 480 µF

Ordering codes and packing units (lead spacing 37.5 mm)

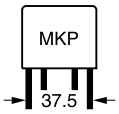
C_R[1] µF	Max. dimensions w × h × l mm	P_1 mm	Ordering code (composition see below)	$I_{RMS,max}$[2] 70 °C 10 kHz A	ESR_{typ} 70 °C 10 kHz mΩ	ESL_{typ}[3] 70 °C 10 kHz nH	tan δ 1 kHz 10^{-3}	tan δ 10 kHz 10^{-3}	pcs. MOQ
$V_{R,70\,°C}$ = 450 V DC, $V_{op,85\,°C}$ = 450 V DC									
12	24.0 × 15.0 × 41.5	–	B32776T4126K000	7.0	17.1	19.0	2.2	21.0	1040
16	24.0 × 19.0 × 41.5	–	B32776T4166K000	8.0	13.0	18.0	2.3	21.2	780
30	20.0 × 39.5 × 41.5	10.2	B32776G4306+000	14.0	7.0	11.0	2.3	21.3	640
30	20.0 × 39.5 × 41.5	–	B32776E4306+000	14.0	7.3	28.0	2.4	22.3	640
35	28.0 × 37.0 × 42.0	10.2	B32776G4356+000	16.5	6.0	10.0	2.3	21.4	440
35	28.0 × 37.0 × 42.0	–	B32776E4356+000	16.0	6.4	24.0	2.4	22.6	440
40	28.0 × 37.0 × 42.0	10.2	B32776G4406+000	17.5	5.3	11.0	2.3	21.4	440
40	28.0 × 37.0 × 42.0	–	B32776E4406+000	17.0	5.6	26.0	2.4	22.7	440
40	43.0 × 22.0 × 41.5	20.3	B32776T4406+000	17.0	5.2	13.0	2.3	21.2	280
50	28.0 × 42.5 × 41.5	10.2	B32776G4506+000	20.0	4.3	12.0	2.3	21.7	440
50	28.0 × 42.5 × 41.5	–	B32776E4506+000	19.0	4.7	30.0	2.5	23.8	440
60	30.0 × 45.0 × 42.0	20.3	B32776G4606+000	23.5	3.6	14.0	2.4	22.3	400
60	30.0 × 45.0 × 42.0	–	B32776E4606+000	22.0	4.0	32.0	2.5	24.2	400
65	33.0 × 48.0 × 42.0	20.3	B32776G4656+000	25.5	3.3	14.0	2.3	22.2	180
$V_{R,70\,°C}$ = 575 V DC, $V_{op,85\,°C}$ = 500 V DC									
8.5	24.0 × 15.0 × 41.5	–	B32776T5855+000	6.5	19.9	19.0	1.9	17.2	1040
12	24.0 × 19.0 × 41.5	–	B32776T5126K000	8.0	14.4	18.0	1.9	17.4	780
25	20.0 × 39.5 × 41.5	10.2	B32776G5256K000	14.0	7.0	12.0	1.9	17.5	640
25	20.0 × 39.5 × 41.5	–	B32776E5256K000	13.5	7.4	28.0	2.0	18.3	640
30	28.0 × 37.0 × 42.0	10.2	B32776G5306K000	16.5	5.8	11.0	1.9	17.6	440
30	28.0 × 37.0 × 42.0	–	B32776E5306K000	16.5	6.1	26.0	2.0	18.5	440
30	43.0 × 22.0 × 41.5	20.3	B32776T5306K000	16.5	5.8	13.0	1.9	17.3	280
35	28.0 × 42.5 × 41.5	10.2	B32776G5356+000	19.0	5.0	12.0	1.9	17.8	440
35	28.0 × 42.5 × 41.5	–	B32776E5356+000	18.0	5.3	29.0	2.0	19.0	440
45	30.0 × 45.0 × 42.0	20.3	B32776G5456K000	22.0	4.0	13.0	1.9	17.9	400
45	30.0 × 45.0 × 42.0	–	B32776E5456K000	21.0	4.4	32.0	2.1	19.7	400
50	33.0 × 48.0 × 42.0	20.3	B32776G5506K000	25.0	3.5	14.0	2.0	18.1	180

MOQ = Minimum Order Quantity, consisting of 4 packing units.
Intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:
J = ±5%
K = ±10%

1) Capacitance value measured at 1 kHz
2) Max ripple current I_{RMS} at 70 °C, 10 kHz for $\Delta T \leq 20$ °C at $\Delta ESR_{typ} \leq \pm 5\%$
3) Typical ESL value measured at resonance frequency (see specific graphs of Z vs freq)



Ordering codes and packing units (lead spacing 37.5 mm)

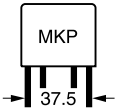
C_R[1] µF	Max. dimensions w × h × l mm	P_1 mm	Ordering code (composition see below)	$I_{RMS,max}$[2] 70 °C 10 kHz A	ESR_{typ} 70 °C 10 kHz mΩ	ESL_{typ}[3] 70 °C 10 kHz nH	tan δ 1 kHz 10^{-3}	tan δ 10 kHz 10^{-3}	pcs. MOQ
$V_{R,70\,°C}$ = 800 V DC, $V_{op,85\,°C}$ = 700 V DC									
6.8	24.0 × 15.0 × 41.5	–	B32776T8685+000	6.0	22.1	18.0	1.7	15.1	1040
8.5	24.0 × 19.0 × 41.5	–	B32776T8855+000	7.5	17.8	18.0	1.7	15.1	780
14	18.0 × 32.5 × 41.5	–	B32776E8146+000	10.0	11.5	23.0	1.8	16.3	720
15	20.0 × 39.5 × 41.5	10.2	B32776G8156+000	12.0	9.6	10.0	1.7	15.2	640
15	20.0 × 39.5 × 41.5	–	B32776E8156+000	11.5	10.3	24.0	1.7	15.7	640
20	28.0 × 37.0 × 42.0	10.2	B32776G8206+000	14.5	7.5	10.0	1.7	15.3	440
20	28.0 × 37.0 × 42.0	–	B32776E8206+000	14.5	7.8	24.0	1.7	15.9	440
20	43.0 × 22.0 × 41.5	20.3	B32776T8206+000	14.5	7.2	14.0	1.7	15.1	280
22	28.0 × 37.0 × 42.0	10.2	B32776G8226+000	15.5	6.8	11.0	1.7	15.3	440
22	28.0 × 37.0 × 42.0	–	B32776E8226+000	15.0	7.1	25.0	1.7	16.0	440
25	28.0 × 42.5 × 41.5	10.2	B32776G8256+000	17.0	6.1	11.0	1.7	15.4	440
25	28.0 × 42.5 × 41.5	–	B32776E8256+000	16.5	6.4	28.0	1.8	16.3	440
30	30.0 × 45.0 × 42.0	20.3	B32776G8306+000	19.5	5.1	12.0	1.7	15.6	400
30	30.0 × 45.0 × 42.0	–	B32776E8306+000	19.0	5.5	30.0	1.8	16.7	400
35	33.0 × 48.0 × 42.0	20.3	B32776G8356+000	22.0	4.3	14.0	1.7	15.7	180
$V_{R,70\,°C}$ = 900 V DC, $V_{op,85\,°C}$ = 800 V DC									
5	24.0 × 15.0 × 41.5	–	B32776T9505+000	5.5	26.1	19.0	1.5	13.4	1040
7.5	24.0 × 19.0 × 41.5	–	B32776T9755K000	7.5	17.8	18.0	1.5	13.5	780
15	20.0 × 39.5 × 41.5	10.2	B32776G9156K000	12.5	9.1	12.0	1.5	13.6	640
15	20.0 × 39.5 × 41.5	–	B32776E9156K000	12.0	9.4	28.0	1.5	14.1	640
16	43.0 × 22.0 × 41.5	20.3	B32776T9166+000	14.0	8.1	14.0	1.5	13.5	280
20	28.0 × 37.0 × 42.0	10.2	B32776G9206K000	15.0	7.0	11.0	1.5	13.6	440
20	28.0 × 37.0 × 42.0	–	B32776E9206K000	15.0	7.3	26.0	1.6	14.2	440
22	28.0 × 42.5 × 41.5	10.2	B32776G9226K000	17.0	6.3	12.0	1.5	13.7	440
22	28.0 × 42.5 × 41.5	–	B32776E9226K000	16.5	6.6	29.0	1.6	14.5	440
25	30.0 × 45.0 × 42.0	20.3	B32776G9256+000	19.0	5.5	13.0	1.5	13.8	400
25	30.0 × 45.0 × 42.0	–	B32776E9256+000	18.5	5.9	32.0	1.6	14.7	400
30	33.0 × 48.0 × 42.0	20.3	B32776G9306+000	21.5	4.7	14.0	1.5	13.9	180

MOQ = Minimum Order Quantity, consisting of 4 packing units.
Intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:
J = ±5%
K = ±10%

1) Capacitance value measured at 1 kHz
2) Max ripple current I_{RMS} at 70 °C, 10 kHz for $\Delta T \leq 20$ °C at $\Delta ESR_{typ} \leq \pm 5\%$
3) Typical ESL value measured at resonance frequency (see specific graphs of Z vs freq)



B32776

MKP DC link – high density series – up to 480 µF

Ordering codes and packing units (lead spacing 37.5 mm)

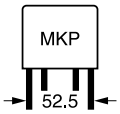
C_R[1] µF	Max. dimensions w × h × l mm	P_1 mm	Ordering code (composition see below)	$I_{RMS,max}$[2] 70 °C 10 kHz A	ESR_{typ} 70 °C 10 kHz mΩ	ESL_{typ}[3] 70 °C 10 kHz nH	tan δ 1 kHz 10^{-3}	tan δ 10 kHz 10^{-3}	pcs. MOQ
$V_{R,70\,°C}$ = 1100 V DC, $V_{op,85\,°C}$ = 920 V DC									
3.9	24.0 × 15.0 × 41.5	–	B32776T0395+000	5.0	30.5	18.0	1.4	12.1	1040
5	24.0 × 19.0 × 41.5	–	B32776T0505+000	6.5	23.6	18.0	1.4	12.1	780
12	20.0 × 39.5 × 41.5	10.2	B32776G0126+000	12.0	10.2	12.0	1.4	12.2	640
12	20.0 × 39.5 × 41.5	–	B32776E0126+000	11.5	10.5	28.0	1.4	12.6	640
13	43.0 × 22.0 × 41.5	20.3	B32776T0136+000	13.0	8.9	14.0	1.4	12.1	280
14	28.0 × 37.0 × 42.0	10.2	B32776G0146+000	13.5	8.7	21.0	1.4	12.2	440
14	28.0 × 37.0 × 42.0	–	B32776E0146+000	13.5	9.0	25.0	1.4	12.6	440
16	28.0 × 42.5 × 41.5	10.2	B32776G0166+000	15.5	7.4	12.0	1.4	12.3	440
16	28.0 × 42.5 × 41.5	–	B32776E0166+000	15.0	7.8	30.0	1.4	12.9	440
20	30.0 × 45.0 × 42.0	20.3	B32776G0206+000	18.0	6.0	14.0	1.4	12.4	400
20	30.0 × 45.0 × 42.0	–	B32776E0206+000	17.5	6.5	32.0	1.4	13.1	400
22	33.0 × 48.0 × 42.0	20.3	B32776G0226+000	21.0	4.9	15.0	1.3	11.4	180
$V_{R,70\,°C}$ = 1300 V DC, $V_{op,85\,°C}$ = 1100 V DC									
2.7	24.0 × 15.0 × 41.5	–	B32776T1275+000	5.0	34.7	19.0	1.1	9.6	1040
3.5	24.0 × 19.0 × 41.5	–	B32776T1355+000	6.0	27.4	18.0	1.1	9.7	780
8.0	20.0 × 39.5 × 41.5	10.2	B32776G1805+000	11.0	12.1	12.0	1.1	9.7	640
8.0	20.0 × 39.5 × 41.5	–	B32776E1805+000	10.5	12.4	24.0	1.2	10.0	640
9.0	43.0 × 22.0 × 41.5	20.3	B32776T1905K000	12.0	10.7	13.0	1.1	9.7	280
10	28.0 × 37.0 × 42.0	10.2	B32776G1106+000	13.0	9.6	11.0	1.1	9.7	440
10	28.0 × 37.0 × 42.0	–	B32776E1106+000	12.5	9.9	26.0	1.2	10.0	440
12	28.0 × 42.5 × 41.5	10.2	B32776G1126+000	14.5	8.1	12.0	1.1	9.8	440
12	28.0 × 42.5 × 41.5	–	B32776E1126+000	14.0	8.5	28.0	1.2	10.1	440
14	30.0 × 45.0 × 42.0	20.3	B32776G1146+000	17.0	6.8	14.0	1.1	10.1	400
14	30.0 × 45.0 × 42.0	–	B32776E1146+000	16.5	7.3	32.0	1.2	10.4	400
16	33.0 × 48.0 × 42.0	20.3	B32776G1166+000	19.0	6.0	15.0	1.1	9.9	180

MOQ = Minimum Order Quantity, consisting of 4 packing units.
Intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:
J = ±5%
K = ±10%

1) Capacitance value measured at 1 kHz
2) Max ripple current I_{RMS} at 70 °C, 10 kHz for $\Delta T \leq 20$ °C at $\Delta ESR_{typ} \leq \pm 5\%$
3) Typical ESL value measured at resonance frequency (see specific graphs of Z vs freq)



Ordering codes and packing units (lead spacing 52.5 mm, P_1 = 20.3 mm)

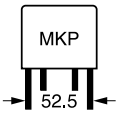
C_R[1]	Max. dimensions w × h × l	Ordering code (composition see below)	$I_{RMS,max}$[2] 70 °C 10 kHz	ESR_{typ} 70 °C 10 kHz	ESL_{typ}[3] 70 °C 10 kHz	tan δ 1 kHz	tan δ 10 kHz	pcs. MOQ
µF	mm		A	mΩ	nH	10^{-3}	10^{-3}	
$V_{R,70\,°C}$ = 450 V DC, $V_{op,85\,°C}$ = 450 V DC								
55	43.0 × 22.0 × 57.5	B32778T4556+000	16.5	7.2	13.0	4.3	41.7	420
75	30.0 × 45.0 × 57.5	B32778G4756+000	21.0	5.6	12.0	4.4	42.6	280
80	30.0 × 45.0 × 57.5	B32778G4806+000	21.5	5.3	13.0	4.4	42.7	280
100	35.0 × 50.0 × 57.5	B32778G4107+000	26.0	4.3	14.0	4.5	43.3	108
110	35.0 × 50.0 × 57.5	B32778G4117K000	27.0	3.9	15.0	4.5	43.6	108
150	130.0 × 22.0 × 57.5	B32778J4157+000	43.5	2.7	4.0	4.4	42.1	80
170	45.0 × 57.0 × 57.5	B32778G4177+000	36.5	2.6	17.0	4.6	45.7	140
180	60.0 × 45.0 × 57.5	B32778G4187+000	39.0	2.5	19.0	4.6	44.6	200
480	130.0 × 58.0 × 57.5	B32778J4487K000	79.5	0.9	6.0	4.8	45.4	40
$V_{R,70\,°C}$ = 575 V DC, $V_{op,85\,°C}$ = 500 V DC								
40	43.0 × 22.0 × 57.5	B32778T5406+000	15.5	8.5	13.0	3.6	34.5	420
60	30.0 × 45.0 × 57.5	B32778G5606+000	20.5	5.8	13.0	3.7	35.3	280
80	35.0 × 50.0 × 57.5	B32778G5806+000	25.5	4.4	15.0	3.7	36.0	108
110	130.0 × 22.0 × 57.5	B32778J5117+000	40.5	3.0	5.0	3.6	34.5	80
120	45.0 × 57.0 × 57.5	B32778G5127+000	34.5	3.1	17.0	3.8	37.2	140
130	60.0 × 45.0 × 57.5	B32778G5137+000	36.5	2.8	19.0	3.8	36.7	200
360	130.0 × 58.0 × 57.5	B32778J5367K000	75.0	1.0	6.0	4.0	37.3	40
$V_{R,70\,°C}$ = 800 V DC, $V_{op,85\,°C}$ = 700 V DC								
30	43.0 × 22.0 × 57.5	B32778T8306+000	14.5	9.8	14.0	3.2	30.2	420
45	30.0 × 45.0 × 57.5	B32778G8456+000	19.5	6.6	14.0	3.2	30.9	280
50	30.0 × 45.0 × 57.5	B32778G8506+000	20.0	6.3	13.0	3.2	30.9	280
55	35.0 × 50.0 × 57.5	B32778G8556+000	23.0	5.6	14.0	3.2	31.1	108
60	35.0 × 50.0 × 57.5	B32778G8606+000	23.5	5.1	15.0	3.3	31.2	108
80	130.0 × 22.0 × 57.5	B32778J8806+000	37.5	3.6	4.0	3.2	30.2	80
90	45.0 × 57.0 × 57.5	B32778G8906+000	32.5	3.5	17.0	3.3	32.2	140
100	60.0 × 45.0 × 57.5	B32778G8107+000	34.5	3.2	19.0	3.3	31.9	200
270	130.0 × 58.0 × 57.5	B32778J8277K000	70.5	1.2	6.0	3.5	32.4	40

MOQ = Minimum Order Quantity, consisting of 4 packing units.
Intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:
J = ±5%
K = ±10%

1) Capacitance value measured at 1 kHz
2) Max ripple current I_{RMS} at 70 °C, 10 kHz for $\Delta T \leq 20$ °C at $\Delta ESR_{typ} \leq \pm 5\%$
3) Typical ESL value measured at resonance frequency (see specific graphs of Z vs freq)



B32778

MKP DC link – high density series – up to 480 µF

Ordering codes and packing units (lead spacing 52.5 mm, P_1 = 20.3 mm)

C_R[1] µF	Max. dimensions w × h × l mm	Ordering code (composition see below)	$I_{RMS,max}$[2] 70 °C 10 kHz A	ESR_{typ} 70 °C 10 kHz mΩ	ESL_{typ}[3] 70 °C 10 kHz nH	tan δ 1 kHz 10^{-3}	tan δ 10 kHz 10^{-3}	pcs. MOQ
$V_{R,70\,°C}$ = 900 V DC, $V_{op,85\,°C}$ = 800 V DC								
25	43.0 × 22.0 × 57.5	B32778T9256+000	13.5	10.7	13.0	2.8	26.8	420
35	30.0 × 45.0 × 57.5	B32778G9356+000	18.0	7.7	13.0	2.9	27.3	280
50	35.0 × 50.0 × 57.5	B32778G9506K000	22.5	5.6	15.0	2.9	27.7	108
70	45.0 × 57.0 × 57.5	B32778G9706+000	31.0	3.8	18.0	3.0	28.5	140
70	130.0 × 22.0 × 57.5	B32778J9706K000	36.0	3.8	4.0	2.9	27.2	80
75	60.0 × 45.0 × 57.5	B32778G9756+000	32.5	3.6	20.0	2.9	28.2	200
210	130.0 × 58.0 × 57.5	B32778J9217K000	66.0	1.3	6.0	3.1	28.6	40
$V_{R,70\,°C}$ = 1100 V DC, $V_{op,85\,°C}$ = 920 V DC								
20	43.0 × 22.0 × 57.5	B32778T0206+000	13.0	11.9	13.0	2.6	24.1	420
30	30.0 × 45.0 × 57.5	B32778G0306+000	17.5	8.2	13.0	2.6	24.5	280
40	35.0 × 50.0 × 57.5	B32778G0406+000	21.5	6.2	15.0	2.7	25.9	108
58	45.0 × 57.0 × 57.5	B32778G0586+000	29.0	4.3	17.0	2.7	25.4	140
60	60.0 × 45.0 × 57.5	B32778G0606+000	30.5	4.0	19.0	2.7	25.2	200
60	130.0 × 22.0 × 57.5	B32778J0606+000	34.5	4.1	4.0	2.7	25.1	80
200	130.0 × 58.0 × 57.5	B32778J0207K000	66.0	1.4	6.0	3.0	26.8	40
$V_{R,70\,°C}$ = 1300 V DC, $V_{op,85\,°C}$ = 1100 V DC								
14	43.0 × 22.0 × 57.5	B32778T1146+000	12.0	13.8	13.0	2.1	19.5	420
20	30.0 × 45.0 × 57.5	B32778G1206+000	16.0	9.7	13.0	2.1	19.8	280
25	35.0 × 50.0 × 57.5	B32778G1256+000	19.0	7.8	15.0	2.1	19.9	108
27	35.0 × 50.0 × 57.5	B32778G1276+000	19.5	7.3	15.0	2.1	20.0	108
38	130.0 × 22.0 × 57.5	B32778J1386+000	31.5	5.1	4.0	2.1	19.5	80
40	45.0 × 57.0 × 57.5	B32778G1406+000	26.5	5.0	17.0	2.2	20.3	140
42	60.0 × 45.0 × 57.5	B32778G1426+000	28.0	4.7	19.0	2.2	20.2	200
120	130.0 × 58.0 × 57.5	B32778J1127K000	58.5	1.7	6.0	2.3	20.5	40

MOQ = Minimum Order Quantity, consisting of 4 packing units.
Intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:
J = ±5%
K = ±10%

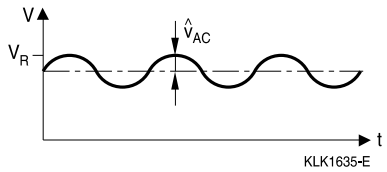
1) Capacitance value measured at 1 kHz
2) Max ripple current I_{RMS} at 70 °C, 10 kHz for $\Delta T \leq 20$ °C at $\Delta ESR_{typ} \leq \pm 5\%$
3) Typical ESL value measured at resonance frequency (see specific graphs of Z vs freq)

Technical data

Reference standard: IEC 61071.
All data given at T = 20 °C, unless otherwise specified.

Operating temperature range (case)	Max. operating temperature, $T_{op,max}$ +105 °C Upper category temperature T_{max} +105 °C Lower category temperature T_{min} –40 °C					
Insulation Resistance R_{ins} given as time constant $\tau = C_R \cdot R_{ins}$, rel. humidity ≤ 65% (minimum as-delivered values)	τ > 10 000 s (after 1 min.) For $V_R \geq$ 500 V measured at 500 V For V_R < 500 V measured at V_R					
DC test voltage between terminals (10 s)	1.5 · V_R					
Voltage test terminal to case (10 s)	2110 V AC, 50 Hz					
Pulse Handling Capability (V/µs)	I_P (A) / C (µF)					
Reliability: Failure rate λ	10 fit (≤ 1 · 10^{-9}/h) at 0.5 · V_R, 40 °C For conversion to other operating conditions, refer to chapter "Quality assurance", data book 2009 "Film capacitors", page 442.					
Service life t_{SL}	100 000 h at V_R and 70 °C					
V_R (V DC)	450	575	800	900	1100	1300
Continuous operation voltage V_{op} (V DC) at 70 °C	450	575	800	900	1100	1300
Continuous operation voltage V_{op} (V DC) at 85 °C	450	500	700	800	920	1100
For temperatures between 85 °C and 105 °C	1.33%/°C of V_{op} derating compared to V_{op} at 85 °C					

Typical waveforms



KLK1635-E

KLK1267-S

Restrictions:
V_R: Maximum operating peak voltage of either polarity but of a non-reversing waveform, for which the capacitor has been designed for continuous operation.
$\hat{v}_{AC} \leq 0.2 \cdot V_R$

Overvoltage	Maximum duration within one day	Observation
$1.1 \cdot V_R$	30% of on-load duration	System regulation
$1.15 \cdot V_R$	30 min.	System regulation
$1.2 \cdot V_R$	5 min.	System regulation
$1.3 \cdot V_R$	1 min.	System regulation

NOTE 1 An overvoltage equal to $1.5 \cdot V_R$ for 30 ms is permitted 1000 times during the life of the capacitor.

The amplitudes of the overvoltages that may be tolerated without significant reduction in the life time of the capacitor depend on their duration, the number of application and the capacitor temperature.

In addition these values assume that the overvoltages may appear when the internal temperature of the capacitor is less than 0 °C but within the temperature category.

NOTE 2 The average applied voltage must not be higher than the specified voltage.

Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in V/µs.

Note:
The values of dV/dt provided below must not be exceeded in order to avoid damaging the capacitor.

dV/dt values

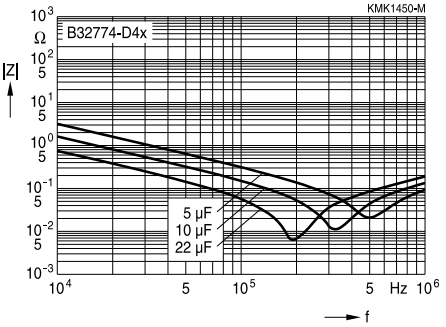
Lead spacing	27.5 mm				37.5 mm					
Type	B32774				B32776					
V_R (V DC)	450	800	1100	1300	450	575	800	900	1100	1300
dV/dt in V/µs	30	40	75	100	21	22	22	35	54	73

Lead spacing	52.5 mm					
Type	B32778					
V_R (V DC)	450	575	800	900	1100	1300
dV/dt in V/µs	14	14	15	22	35	50

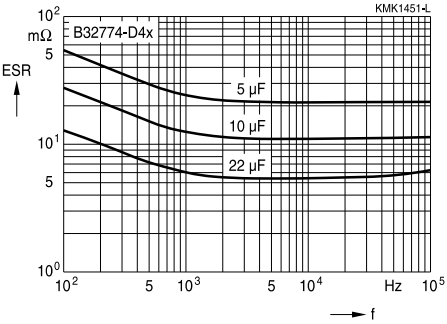
Characteristics curves

Additional technical information can be found under "Design support" on www.epcos.com

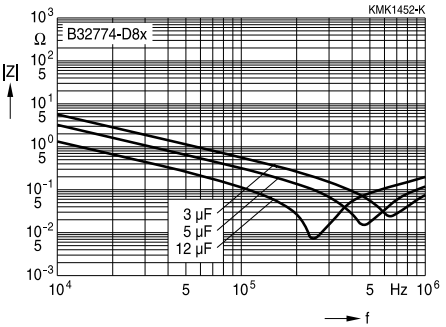
Impedance Z versus frequency f
(typical values)
Lead spacing 27.5 mm / B32774D4*



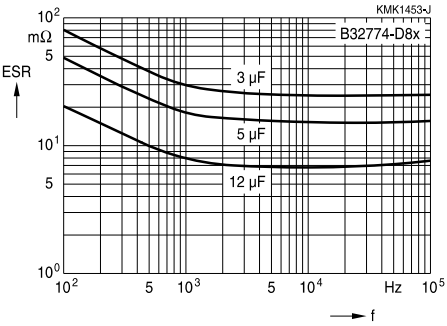
ESR versus frequency f
(typical values)
Lead spacing 27.5 mm / B32774D4*



Impedance Z versus frequency f
(typical values)
Lead spacing 27.5 mm / B32774D8*

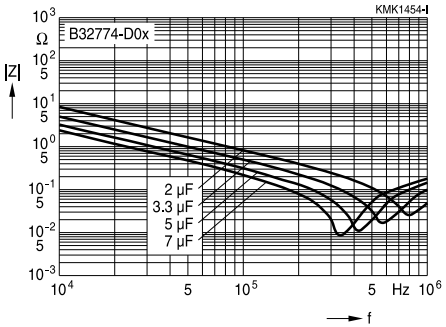


ESR versus frequency f
(typical values)
Lead spacing 27.5 mm / B32774D8*

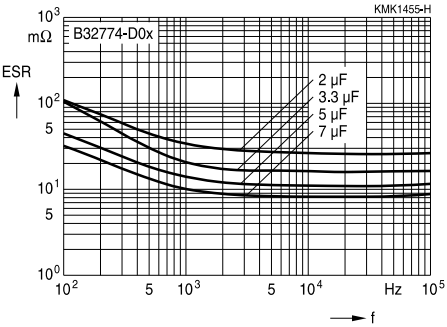


Characteristics curves

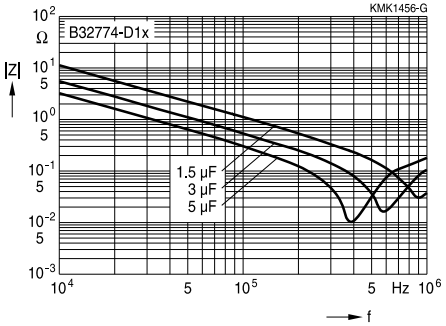
Impedance Z versus frequency f
(typical values)
Lead spacing 27.5 mm / B32774D0*



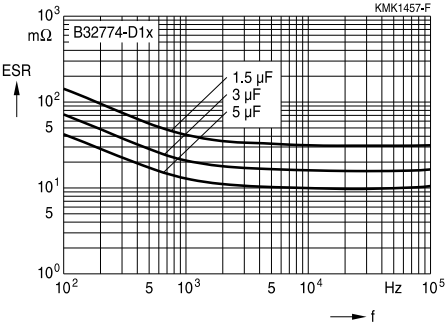
ESR versus frequency f
(typical values)
Lead spacing 27.5 mm / B32774D0*



Impedance Z versus frequency f
(typical values)
Lead spacing 27.5 mm / B32774D1*

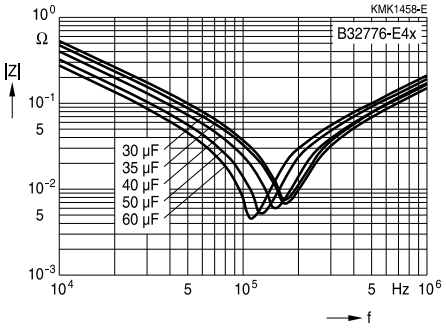


ESR versus frequency f
(typical values)
Lead spacing 27.5 mm / B32774D1*

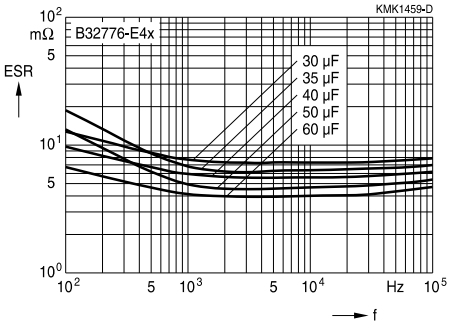


Characteristics curves

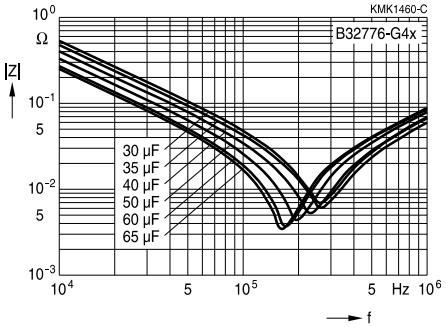
Impedance Z versus frequency f
(typical values)
Lead spacing 37.5 mm / B32776-E4x



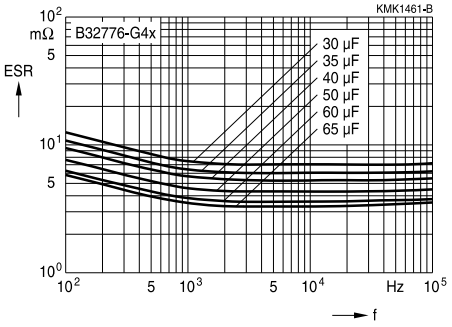
ESR versus frequency f
(typical values)
Lead spacing 37.5 mm / B32776-E4x

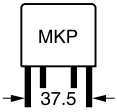


Impedance Z versus frequency f
(typical values)
Lead spacing 37.5 mm / B32776-G4x



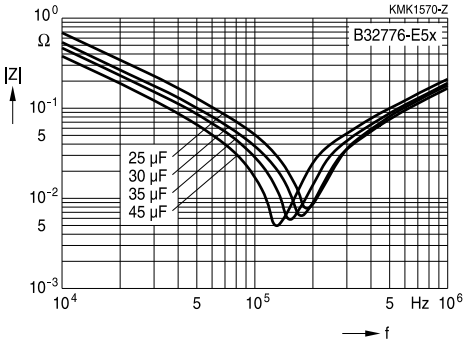
ESR versus frequency f
(typical values)
Lead spacing 37.5 mm / B32776-G4x



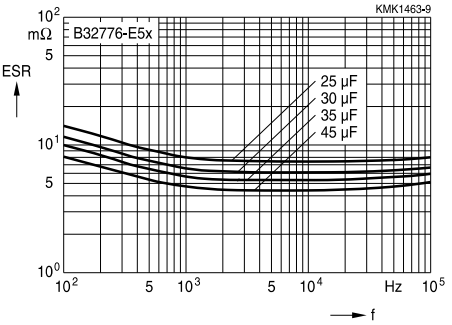


Characteristics curves

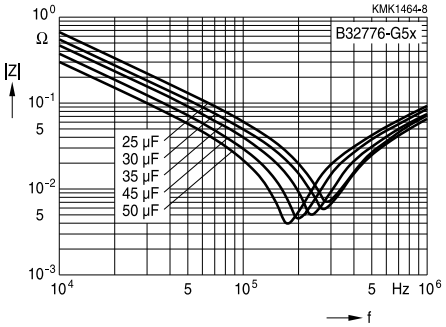
Impedance Z versus frequency f
(typical values)
Lead spacing 37.5 mm / B32776-E5x



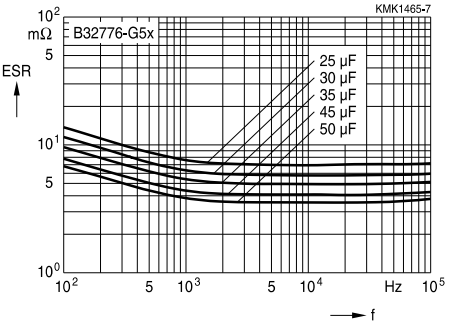
ESR versus frequency f
(typical values)
Lead spacing 37.5 mm / B32776-E5x



Impedance Z versus frequency f
(typical values)
Lead spacing 37.5 mm / B32776-G5x

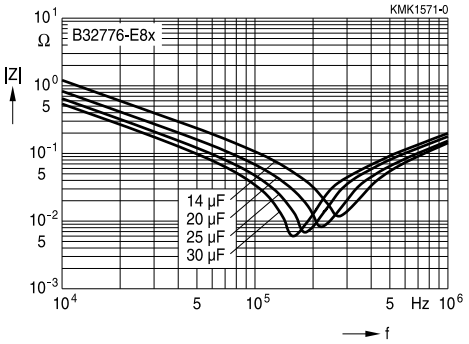


ESR versus frequency f
(typical values)
Lead spacing 37.5 mm / B32776-G5x

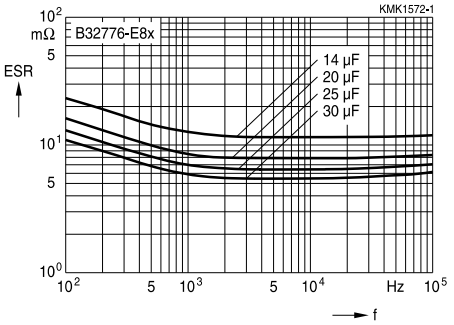


Characteristics curves

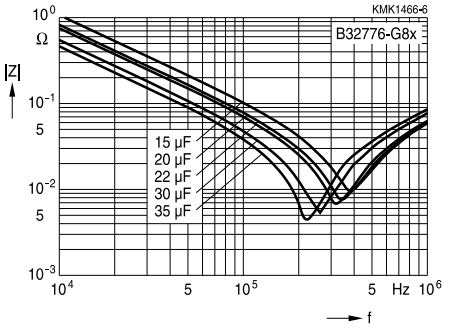
Impedance Z versus frequency f
(typical values)
Lead spacing 37.5 mm / B32776-E8x



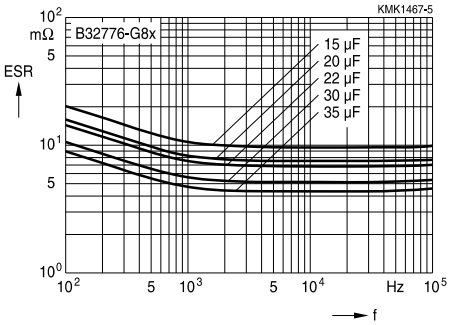
ESR versus frequency f
(typical values)
Lead spacing 37.5 mm / B32776-E8x

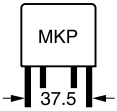


Impedance Z versus frequency f
(typical values)
Lead spacing 37.5 mm / B32776-G8x



ESR versus frequency f
(typical values)
Lead spacing 37.5 mm / B32776-G8x



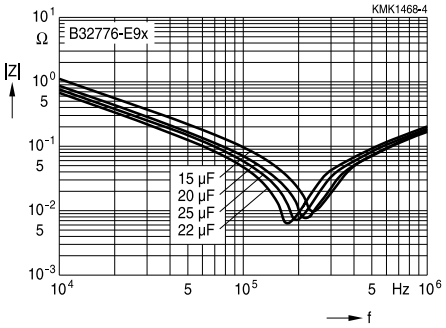


B32776

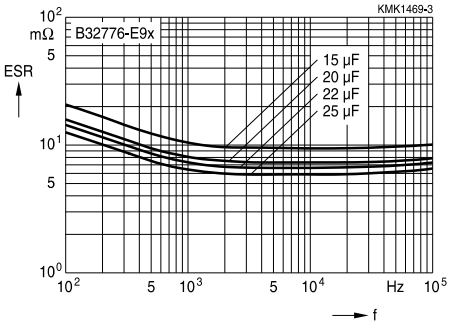
MKP DC link – high density series – up to 480 µF

Characteristics curves

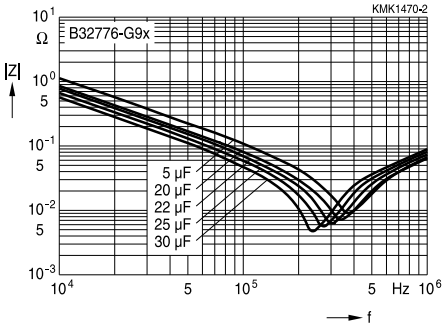
Impedance Z versus frequency f
(typical values)
Lead spacing 37.5 mm / B32776-E9x



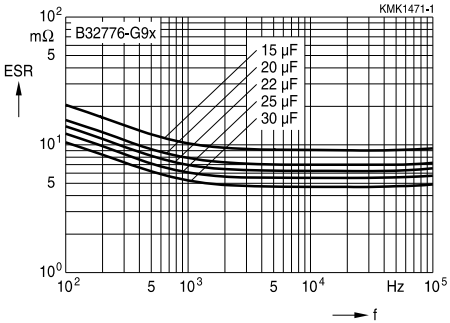
ESR versus frequency f
(typical values)
Lead spacing 37.5 mm / B32776-E9x



Impedance Z versus frequency f
(typical values)
Lead spacing 37.5 mm / B32776-G9x

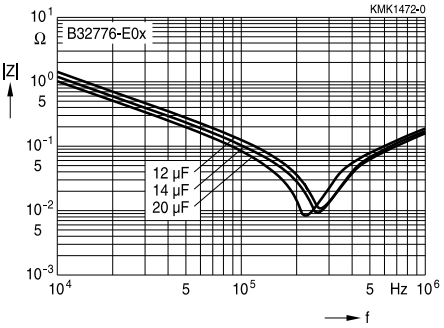


ESR versus frequency f
(typical values)
Lead spacing 37.5 mm / B32776-G9x

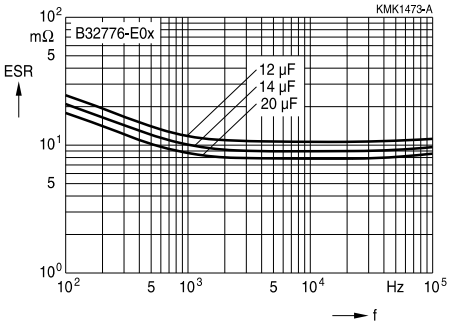


Characteristics curves

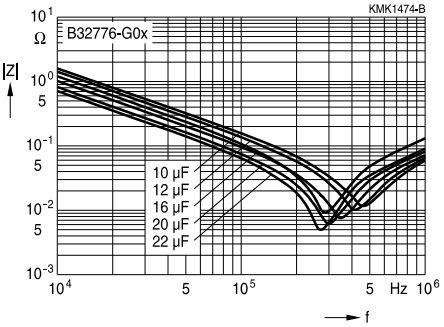
Impedance Z versus frequency f
(typical values)
Lead spacing 37.5 mm / B32776-E0x



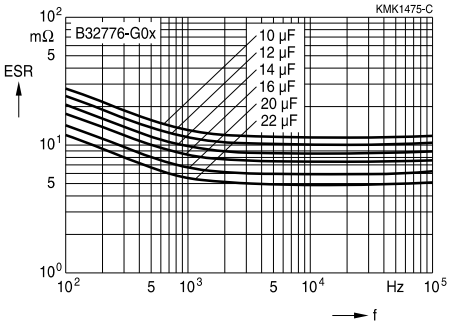
ESR versus frequency f
(typical values)
Lead spacing 37.5 mm / B32776-E0x

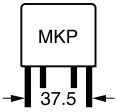


Impedance Z versus frequency f
(typical values)
Lead spacing 37.5 mm / B32776-G0x



ESR versus frequency f
(typical values)
Lead spacing 37.5 mm / B32776-G0x



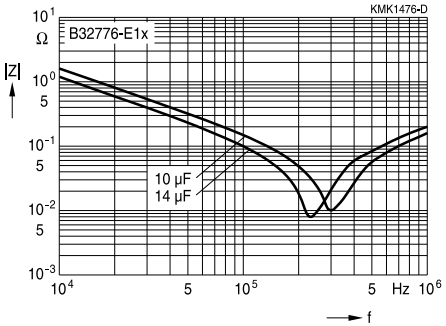


B32776

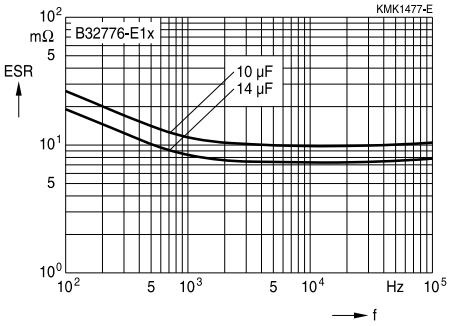
MKP DC link – high density series – up to 480 µF

Characteristics curves

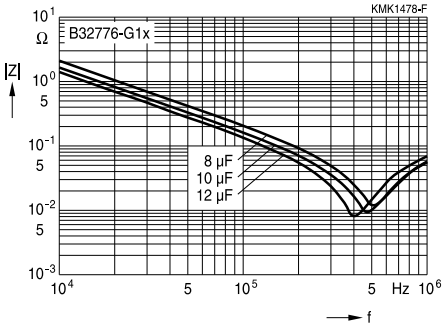
Impedance Z versus frequency f
(typical values)
Lead spacing 37.5 mm / B32776-E1x



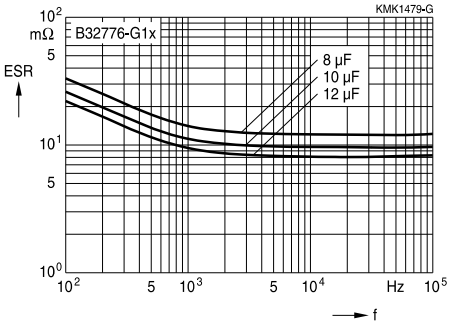
ESR versus frequency f
(typical values)
Lead spacing 37.5 mm / B32776-E1x



Impedance Z versus frequency f
(typical values)
Lead spacing 37.5 mm / B32776-G1x

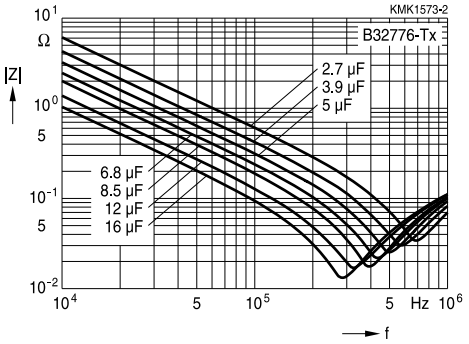


ESR versus frequency f
(typical values)
Lead spacing 37.5 mm / B32776-G1x

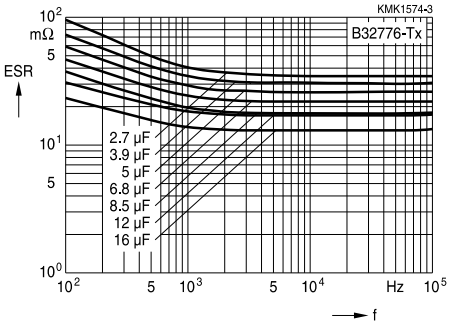


Characteristics curves

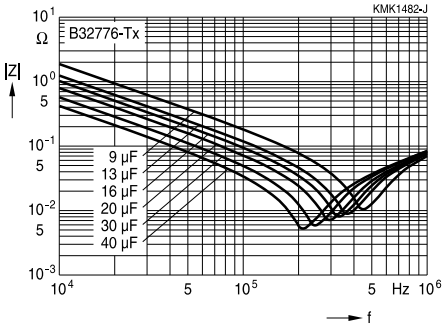
Impedance Z versus frequency f
(typical values)
Lead spacing 37.5 mm / B32776-Tx / 2-pins



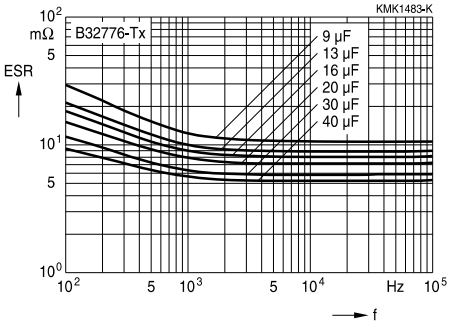
ESR versus frequency f
(typical values)
Lead spacing 37.5 mm / B32776-Tx / 2-pins

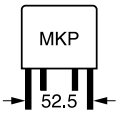


Impedance Z versus frequency f
(typical values)
Lead spacing 37.5 mm / B32776-Tx / 4-pins



ESR versus frequency f
(typical values)
Lead spacing 37.5 mm / B32776-Tx / 4-pins



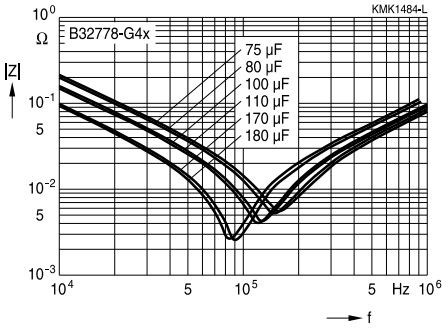


B32778

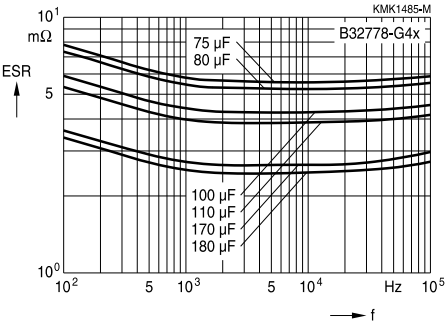
MKP DC link – high density series – up to 480 µF

Characteristics curves

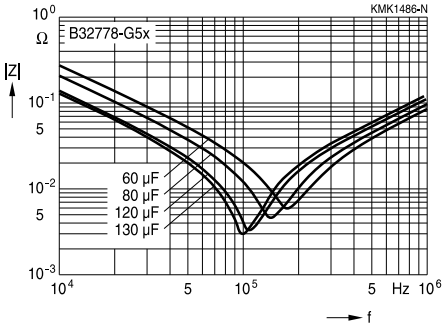
Impedance Z versus frequency f
(typical values)
Lead spacing 52.5 mm / B32778-G4x



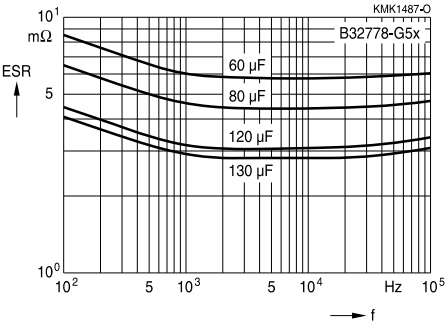
ESR versus frequency f
(typical values)
Lead spacing 52.5 mm / B32778-G4x



Impedance Z versus frequency f
(typical values)
Lead spacing 52.5 mm / B32778-G5x

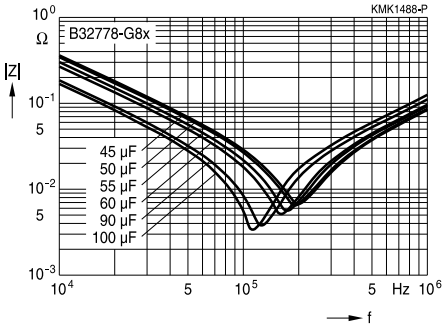


ESR versus frequency f
(typical values)
Lead spacing 52.5 mm / B32778-G5x

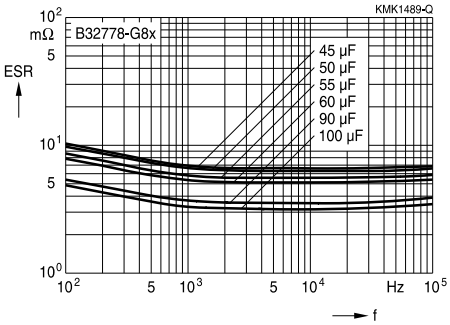


Characteristics curves

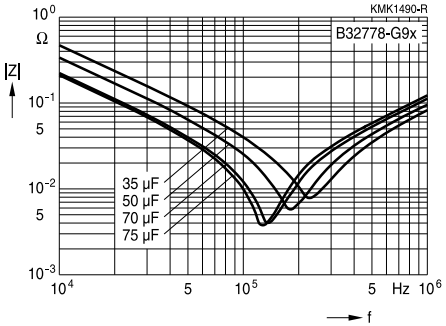
Impedance Z versus frequency f
(typical values)
Lead spacing 52.5 mm / B32778-G8x



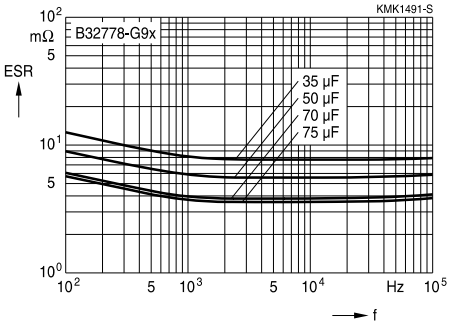
ESR versus frequency f
(typical values)
Lead spacing 52.5 mm / B32778-G8x

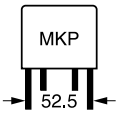


Impedance Z versus frequency f
(typical values)
Lead spacing 52.5 mm / B32778-G9x



ESR versus frequency f
(typical values)
Lead spacing 52.5 mm / B32778-G9x



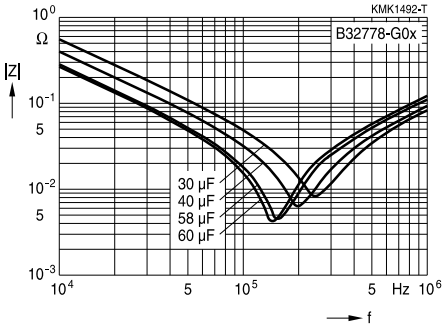


B32778

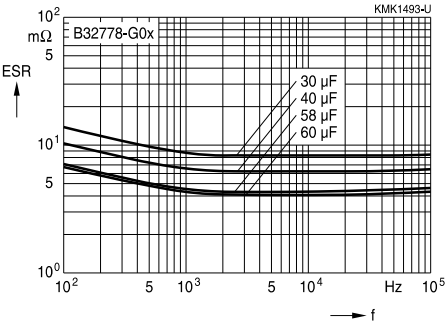
MKP DC link – high density series – up to 480 µF

Characteristics curves

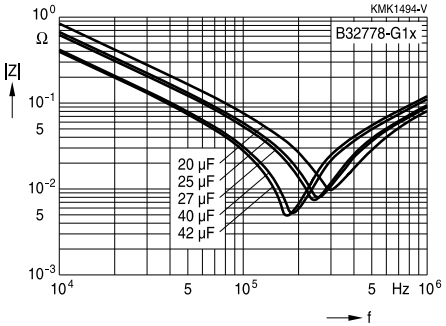
Impedance Z versus frequency f
(typical values)
Lead spacing 52.5 mm / B32778-G0x



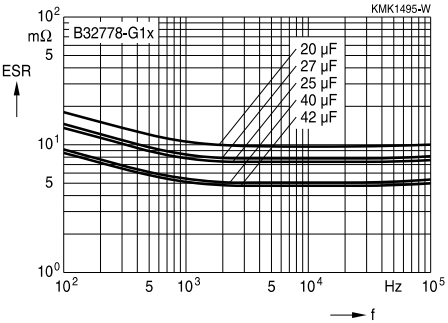
ESR versus frequency f
(typical values)
Lead spacing 52.5 mm / B32778-G0x



Impedance Z versus frequency f
(typical values)
Lead spacing 52.5 mm / B32778-G1x

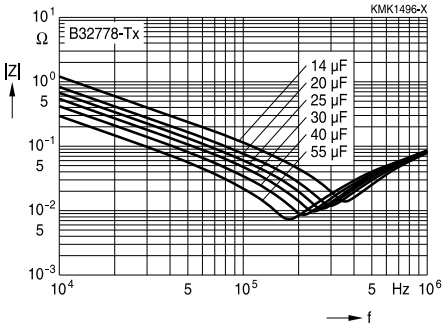


ESR versus frequency f
(typical values)
Lead spacing 52.5 mm / B32778-G1x

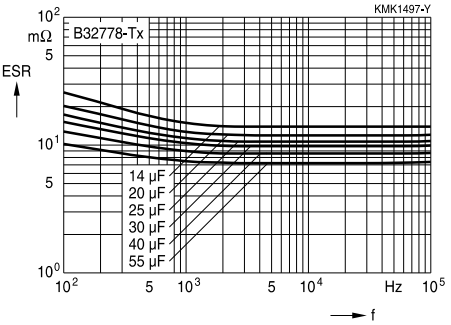


Characteristics curves

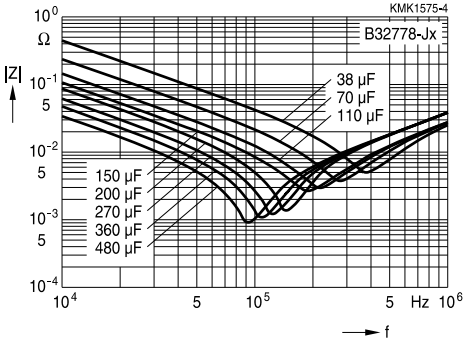
Impedance Z versus frequency f
(typical values)
Lead spacing 52.5 mm / B32778-Tx



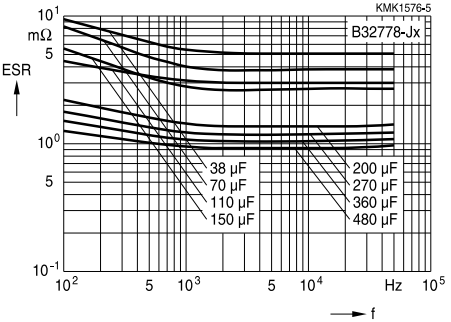
ESR versus frequency f
(typical values)
Lead spacing 52.5 mm / B32778-Tx

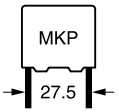


Impedance Z versus frequency f
(typical values)
Lead spacing 52.5 mm / B32778-Jx



ESR versus frequency f
(typical values)
Lead spacing 52.5 mm / B32778-Jx





B32774

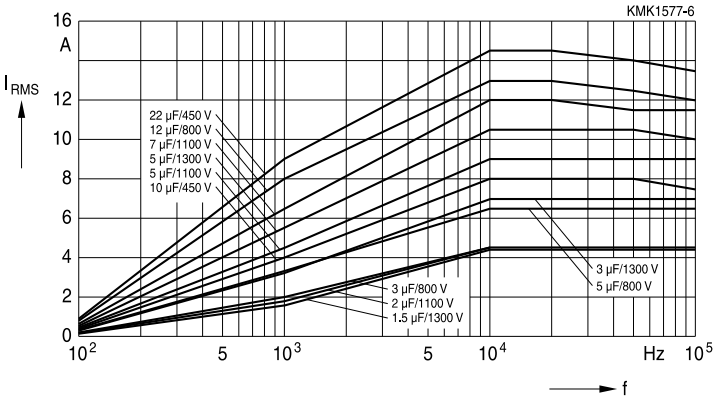
MKP DC link – high density series – up to 480 µF

Characteristics curves

Permissible current I_{RMS} versus frequency f at 70 °C

Lead spacing 27.5 mm

B32774-Dx

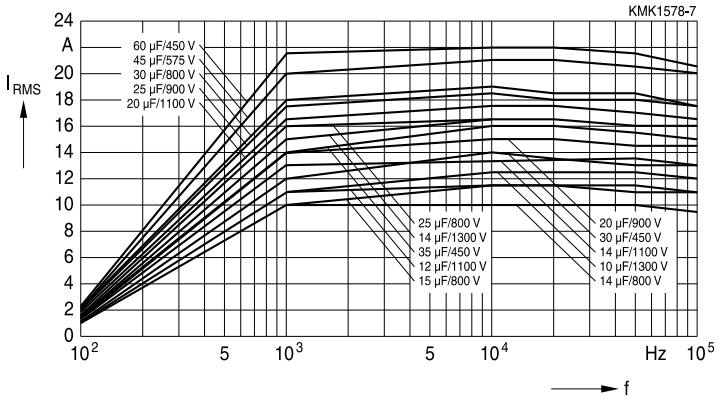


Characteristics curves

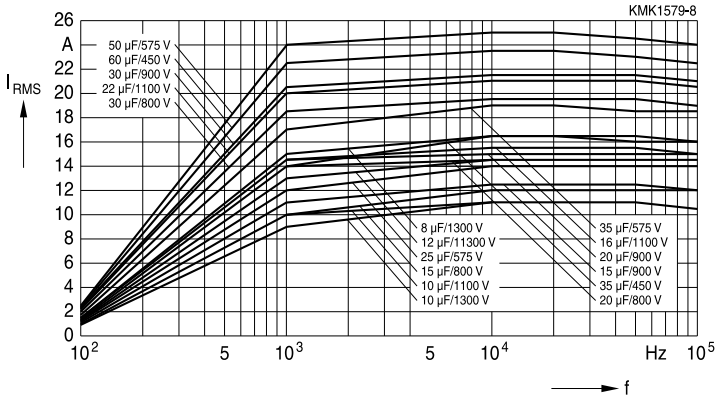
Permissible current I_{RMS} versus frequency f at 70 °C

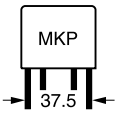
Lead spacing 37.5 mm

B32776-Ex



B32776-Gx





B32776

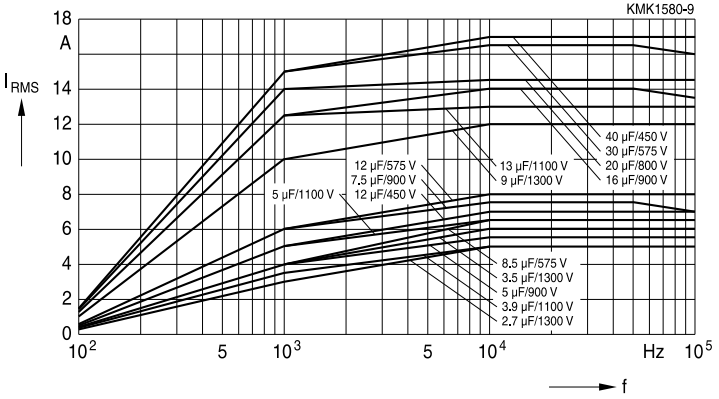
MKP DC link – high density series – up to 480 µF

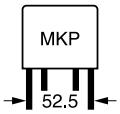
Characteristics curves

Permissible current I_{RMS} versus frequency f at 70 °C

Lead spacing 37.5 mm

B32776-Tx



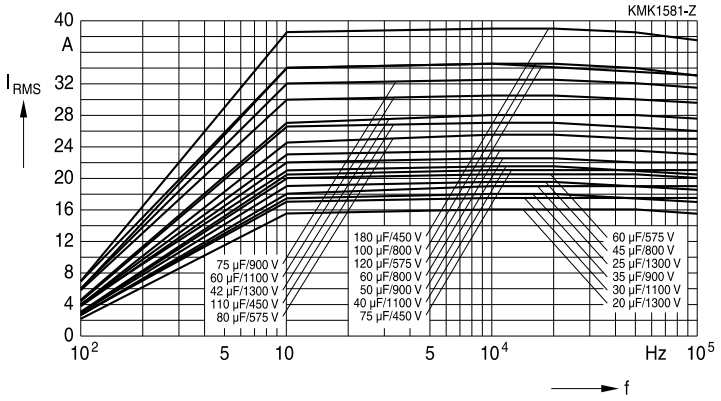


Characteristics curves

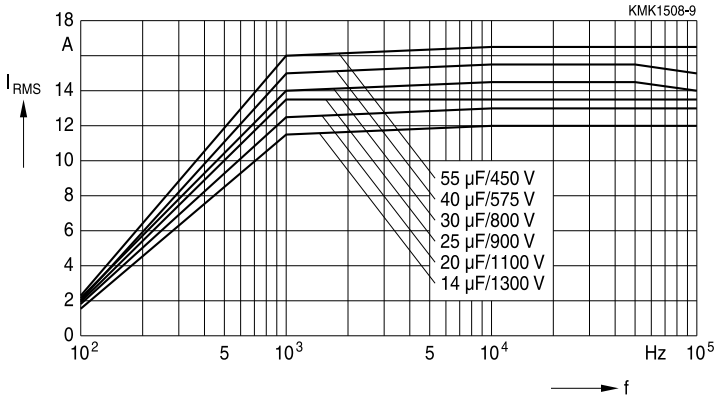
Permissible current I_{RMS} versus frequency f at 70 ° C

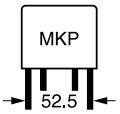
Lead spacing 52.5 mm

B32778-Gx, 4 pins



B32778-Tx, 4 pins





B32778

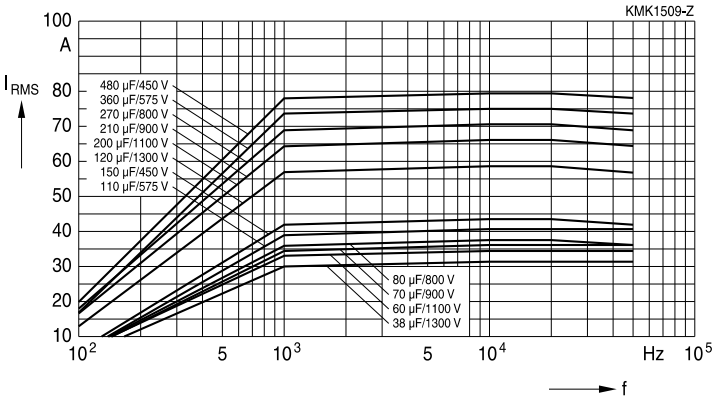
MKP DC link – high density series – up to 480 µF

Characteristics curves

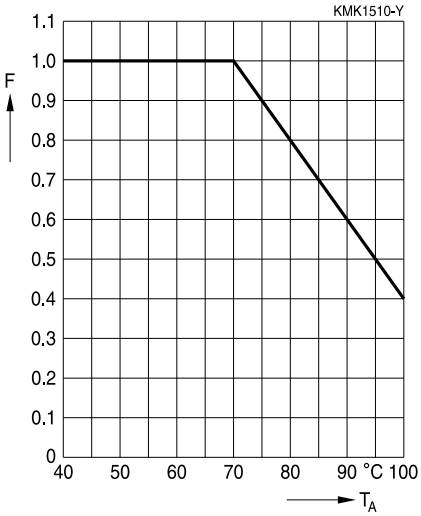
Permissible current I_{RMS} versus frequency f at 70 ° C

Lead spacing 52.5 mm

B32778-Jx, 12 pins



Curves Characteristics (Irms derating vs temperature)



Maximum I_{RMS} current as function of the ambient temperature: I_{RMS} (T_{amb}) = Factor x I_{RMS} (70 ºC)

Heat transference for self heating calculation

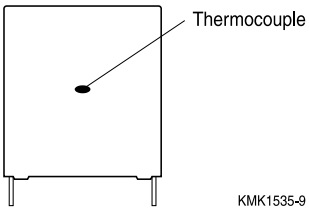


Figure 1

BOX DIMENSIONS			EQUIVALENT HEAT COEFFICIENT
w (mm)	h (mm)	l (mm)	G (mW/°C)
11.0	19.0	31.5	25
11.0	21.0	31.5	28
12.5	21.5	31.5	30
13.5	23.0	31.5	32
14.0	24.5	31.5	35
15.0	24.5	31.5	36
16.0	32.0	31.5	45
18.0	27.5	31.5	44
18.0	33.0	31.5	48
19.0	30.0	31.5	48
20.0	11.0	31.5	65
21.0	31.0	31.5	51
22.0	36.5	31.5	58
12.0	22.0	41.5	70
14.0	25.0	41.5	43
16.0	28.5	41.5	50
18.0	32.5	41.5	59
20.0	39.5	41.5	72
24.0	19.0	41.5	50
24.0	15.0	41.5	44
28.0	37.0	42.0	83
28.0	42.5	41.5	90
30.0	45.0	42.0	100
33.0	48.0	42.0	100
43.0	22.0	41.5	80
30.0	45.0	57.5	125
35.0	50.0	57.5	145
43.0	22.0	57.5	103
45.0	57.0	57.5	185
60.0	45.0	57.5	192
130.0	22.0	57.5	200
130.0	58.0	57.5	300

The equivalent heat coefficient **"G (mW/ºC)"** is given for measuring the temperature on the lateral surface of the plastic box as figure 1 shows. By using a thermocouple and avoiding effect of radiation and convection the temperature measured during operation conditions should be a result of the dissipated power divided by the equivalent heat coefficient.

Self Heating by power dissipation & equivalent heat coefficient

The I_{RMS} and consequently the power dissipation must be limited during operation in order to not exceed the maximum limit of ΔT allowed for this series. ΔT_{max} given for this series is equal or lower than 20 °C at rated temperature (70 °C), for higher ambient temperatures ΔT_{max} (T) will have the same derating factor than I_{RMS} vs temperature and then an equivalent derating as per:

$$\Delta T_{max}\,(T) = (\text{Factor})^2 \times \Delta T\ (70\ °C).$$

For any particular I_{RMS} the ΔT may be calculated by:

$$\Delta T\ (°C) = P_{dis}\,(mW) / G(mW/°C)$$

Where ΔT (°C) is the difference between the temperature measured on the box (see figure 1) and the ambient temperature when capacitor is working during normal operation;

$$\Delta T\ (°C) = T_{op}(°C) - T_{amb}\,(°C).$$

It represents the increasing of temperature provoked by the I_{RMS} during operation.

G (mW/°C) is the equivalent heat coefficient described above and P_{dis} (mW) is the dissipated power defined by:

$$P_{dis}\,(mW) = ESR_{typ}\,(m\Omega) \times I_{rms}{}^2\,(A_{RMS}).$$

Example for thermal calculation:

We will take as reference B32778G0306K (30 µF/1100 V) type for thermal calculation. Considering the following load and capacitor characteristics:

I_{RMS} : 12 A_{RMS} at 20 kHz T_{amb}: 85 °C 30 x 45 x 57.5 box
G (mW/°C): 125

Then we have to find the ESR_{typ} at 20 kHz what is approx . 8.2 mΩ.
So according to:

$$P_{dis}\,(mW) = ESR_{typ}(m\Omega) \times I_{rms}{}^2(A_{RMS})$$

we have the following:

$$P_{dis}\,(mW) = 8.2\ m\Omega \times 12\ A_{RMS}{}^2 = 1181\ mW$$

and as per:

$$\Delta T\ (°C) = P_{dis}\,(mW) / G\ (mW/°C)$$

we have the following:

$$\Delta T\ (°C) = 1181\ (mW) / 125\ (mW/°C) = 9.5\ °C$$

What is below of the

$$\Delta T_{max}\ (85\ °C) = (\text{Factor})^2 \times \Delta T\ (70\ °C) = (0.7)^2 \times 20\ °C = 9.8\ °C$$

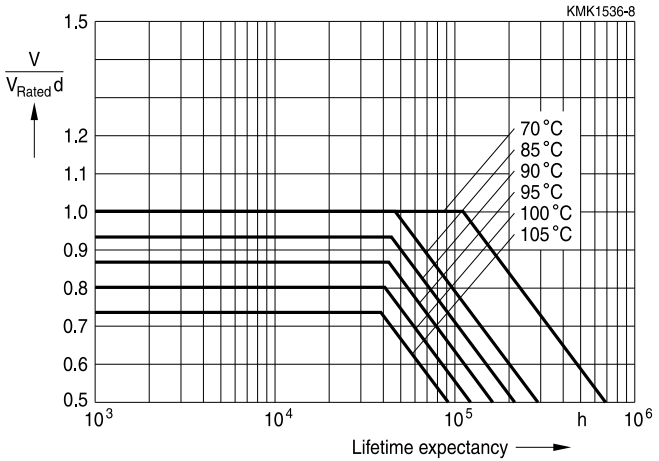
On the other hand we may confirm that max I_{RMS} at 20 kHz at 70 °C = 17.5 A_{RMS}

And then max I_{RMS} for 85 °C of ambient temperature is defined as follows:

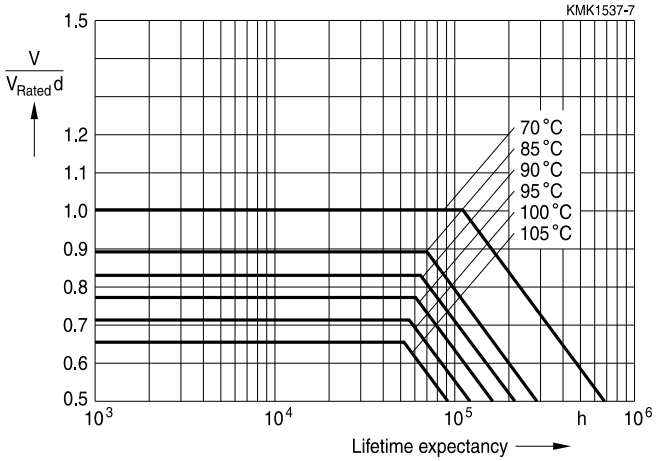
$$I_{RMS}\ (85\ °C) = \text{Factor} \times I_{RMS}\ (70\ °C) = 0.7 \times 17.5\ A_{RMS} = 12.25\ A_{RMS}$$

What confirms once again that I_{RMS} (12 A_{RMS} at 20 kHz) is below the max specified for such frequency and ambient temperature.

Life time expectancy - typical curve (450 V DC / B3277x-X4



Life time expectancy - typical curve (575 V DC / 800 V DC / 900 V DC / 1100 V DC / 1300 V DC / B3277X-5/8/9/0/1)



Note: Confidence level of 95%

Testing and Standards

Test	Reference	Conditions of test		Performance requirements
Electrical Parameters (Routine test)	IEC 61071-11	Voltage between terminals, 1.5 V_R, during 10 s Insulation resistance, R_{INS} at V_R if V_R < 500 V or 500 V if $V_R \geq$ 500 V Capacitance, C at 1 kHz (room temperature) Dissipation factor, tan δ at 1/10 kHz (room temperature)		Within specified limits
Robustness of terminations (Type test)	IEC 60068-2-21	Tensile strength (test Ua1) Wire diameter	Tensile force 10 N 20 N	Capacitance and tan δ within specified limits
		$0.5 < d_1 \leq 0.8$ mm $0.8 < d_1 \leq 1.25$ mm		
Resistance to soldering heat (Type test)	IEC 60068-2-20, test Tb, method 1A	Solder bath temperature at 260 ± 5 °C, immersion for 10 seconds		$\Delta C/C_0 \leq 2\%$ $I\Delta \tan \delta I \leq 0.002$
Rapid change of temperature (Type test)	IEC 60384-16	T_A = lower category temperature T_B = upper category temperature Five cycles, duration t = 30 min.		$I\Delta C/C_0 I \leq 2\%$ $I\Delta \tan \delta I \leq 0.002$ $R_{INS} \geq 50\%$ of initial limit
Vibration (Type test)	IEC 60384-16	Test F_C: vibration sinusoidal Displacement: 0.75 mm Accleration: 98 m/s² Frequency: 10 Hz ... 500 Hz Test duration: 3 orthogonal axes, 2 hours each axe		No visible damage
Bump (Type test)	IEC 60384-16	Test Eb: Total 4000 bumps with 390 m/s² mounted on PCB 6 ms duration		No visible damage $I\Delta C/C_0 I \leq 2\%$ $I\Delta \tan \delta I \leq 0.002$ $R_{INS} \geq 50\%$ of initial limit
Climatic sequence (Type test)	IEC 60384-16	Dry heat Tb / 16 h. Damp heat cyclic, 1st cycle + 55 °C / 24h / 95% ... 100% RH Cold Ta / 2h Damp heat cyclic, 5 cycles + 55 °C / 24h / 95% ... 100% RH		No visible damage $I\Delta C/C_0 I \leq 3\%$ $I\Delta \tan \delta I \leq 0.001$ $R_{INS} \geq 50\%$ of initial limit
Damp Heat Steady State (Type test)	IEC 60384-16	Test Ca 40 °C / 93% RH / 56 days		No visible damage $I\Delta C/C_0 I \leq 5\%$ $I\Delta \tan \delta I \leq 0.005$ $R_{INS} \geq 50\%$ of initial limit

Test	Reference	Conditions of test	Performance requirements
Endurance (Type test)	IEC 60384-16	70 °C / 1.25 V_R / 1000 hours or 85 °C / 1.25 V_{op} / 1000 hours or 100 °C / 1.25 V_{op} / 1000 hours	No visible damage $\lvert\Delta C/C_0\rvert \leq 5\%$ at 1 kHz $\lvert\Delta \tan\delta\rvert \leq 0.005$ $R_{INS} \geq 50\%$ of initial limit

Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Topic	Safety information	Reference chapter "General technical information"
Storage conditions	Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions.	4.5 "Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"

Topic	Safety information	Reference chapter "Mounting guidelines"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6. EPCOS offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	5.2 "Resistance to vibration"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of capacitors in finished assemblies	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types!	3 "Embedding of capacitors in finished assemblies"

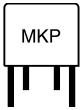
Display of ordering codes for EPCOS products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of EPCOS, or in order-related documents such as shipping notes, order confirmations and product labels. **The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products**. Detailed information can be found on the Internet under www.epcos.com/orderingcodes.

Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
α_C	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
A	Capacitor surface area	Kondensatoroberfläche
β_C	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
C	Capacitance	Kapazität
C_R	Rated capacitance	Nennkapazität
ΔC	Absolute capacitance change	Absolute Kapazitätsänderung
$\Delta C/C$	Relative capacitance change (relative deviation of actual value)	Relative Kapazitätsänderung (relative Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation from rated capacitance)	Kapazitätstoleranz (relative Abweichung vom Nennwert)
dt	Time differential	Differentielle Zeit
Δt	Time interval	Zeitintervall
ΔT	Absolute temperature change (self-heating)	Absolute Temperaturänderung (Selbsterwärmung)
$\Delta \tan \delta$	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
ΔV	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate of voltage rise)	Differentielle Spannungsänderung (Spannungsflankensteilheit)
$\Delta V/\Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f_1	Frequency limit for reducing permissible AC voltage due to thermal limits	Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung
f_2	Frequency limit for reducing permissible AC voltage due to current limit	Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung
f_r	Resonant frequency	Resonanzfrequenz
F_D	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
F_T	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
I_C	Category current (max. continuous current)	Kategoriestrom (max. Dauerstrom)

Symbol	English	German
I_{RMS}	(Sinusoidal) alternating current, root-mean-square value	(Sinusförmiger) Wechselstrom
i_z	Capacitance drift	Inkonstanz der Kapazität
k_0	Pulse characteristic	Impulskennwert
L_S	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
λ_0	Constant failure rate during useful service life	Konstante Ausfallrate in der Nutzungsphase
λ_{test}	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
P_{diss}	Dissipated power	Abgegebene Verlustleistung
P_{gen}	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des Entladekreises
R_i	Internal resistance	Innenwiderstand
R_{ins}	Insulation resistance	Isolationswiderstand
R_P	Parallel resistance	Parallelwiderstand
R_S	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
T	Temperature	Temperatur
τ	Time constant	Zeitkonstante
tan δ	Dissipation factor	Verlustfaktor
tan δ_D	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
tan δ_P	Parallel component of dissipation factor	Parallelanteil des Verlfustfaktors
tan δ_S	Series component of dissipation factor	Serienanteil des Verlustfaktors
T_A	Temperature of the air surrounding the component	Temperatur der Luft, die das Bauteil umgibt
T_{max}	Upper category temperature	Obere Kategorietemperatur
T_{min}	Lower category temperature	Untere Kategorietemperatur
t_{OL}	Operating life at operating temperature and voltage	Betriebszeit bei Betriebstemperatur und -spannung
T_{op}	Operating temperature	Beriebstemperatur
T_R	Rated temperature	Nenntemperatur
T_{ref}	Reference temperature	Referenztemperatur
t_{SL}	Reference service life	Referenz-Lebensdauer



Symbol	English	German
V_{AC}	AC voltage	Wechselspannung
V_C	Category voltage	Kategoriespannung
$V_{C,RMS}$	Category AC voltage	(Sinusförmige) Kategorie-Wechselspannung
V_{CD}	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
V_{ch}	Charging voltage	Ladespannung
V_{DC}	DC voltage	Gleichspannung
V_{FB}	Fly-back capacitor voltage	Spannung (Flyback)
V_i	Input voltage	Eingangsspannung
V_o	Output voltage	Ausgangssspannung
V_{op}	Operating voltage	Betriebsspannung
V_p	Peak pulse voltage	Impuls-Spitzenspannung
V_{pp}	Peak-to-peak voltage Impedance	Spannungshub
V_R	Rated voltage	Nennspannung
$\hat{V}_R$	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
V_{RMS}	(Sinusoidal) alternating voltage, root-mean-square value	(Sinusförmige) Wechselspannung
V_{SC}	S-correction voltage	Spannung bei Anwendung "S-correction"
V_{sn}	Snubber capacitor voltage	Spannung bei Anwendung "Beschaltung"
Z	Impedance	Scheinwiderstand
e	Lead spacing	Rastermaß

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1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application**. As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
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